

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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RENESAS

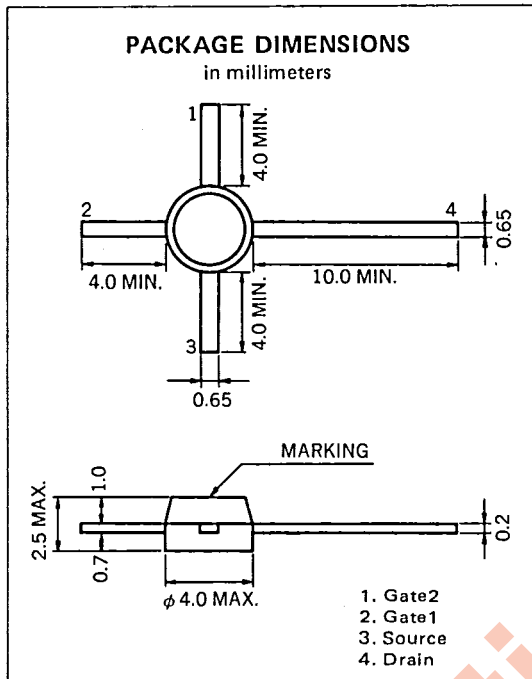
MES FIELD EFFECT TRANSISTOR

3SK174

RF AMP. FOR UHF TV TUNER

N-CHANNEL GaAs DUAL-GATE MES FIELD-EFFECT TRANSISTOR

4PIN DISK MOLD



FEATURES

- Suitable for use as RF amplifier in UHF TV tuner.
- Low C_{rss} : 0.02 pF TYP.
- High G_{PS} : 20 dB TYP.
- Low NF : 1.1 dB TYP.

ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

Drain to Source Voltage	V_{DSX}	13	V
Gate1 to Source Voltage	V_{G1S}	-4.5	V
Gate2 to Source Voltage	V_{G2S}	-4.5	V
Drain Current	I_D	40	mA
Total Power Dissipation	P_T	200	mW
Channel Temperature	T_{ch}	125	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +125	$^\circ\text{C}$

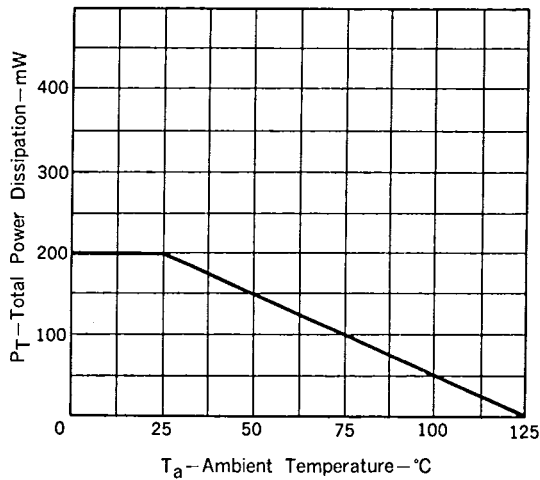
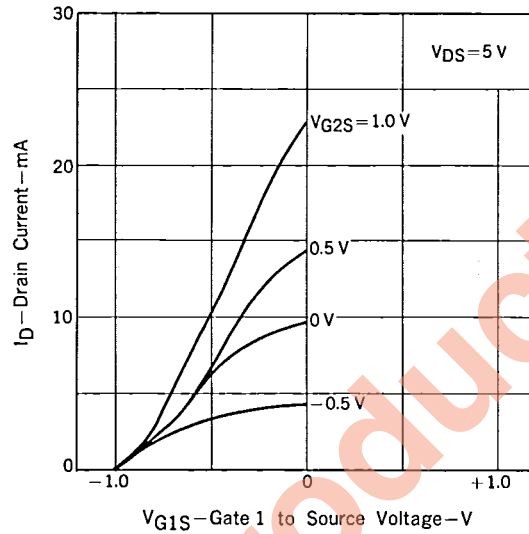
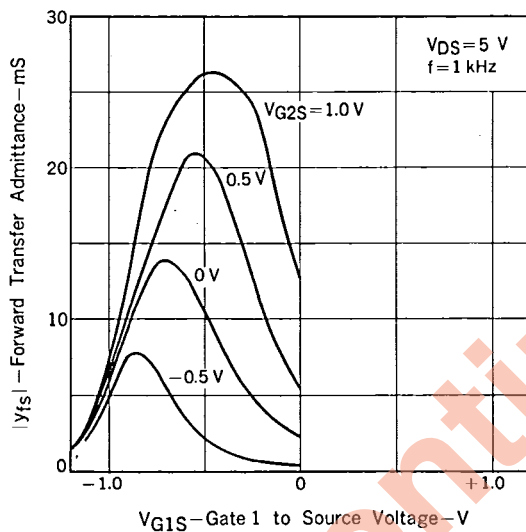
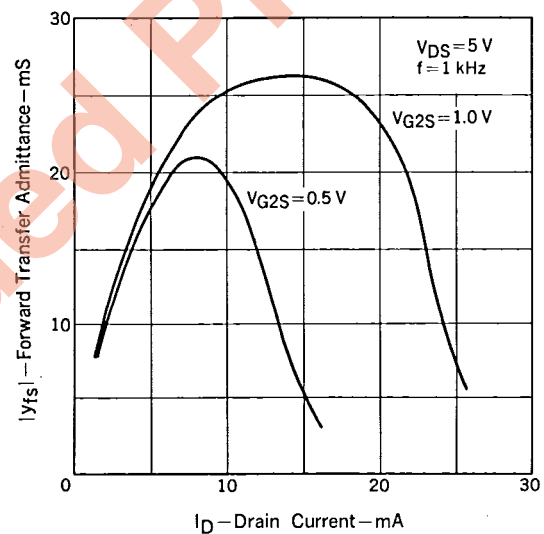
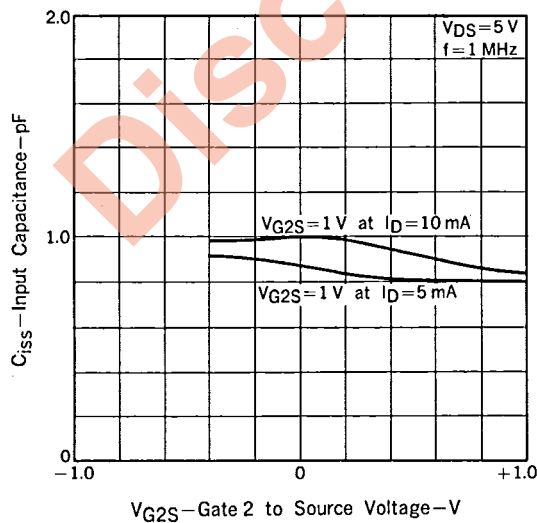
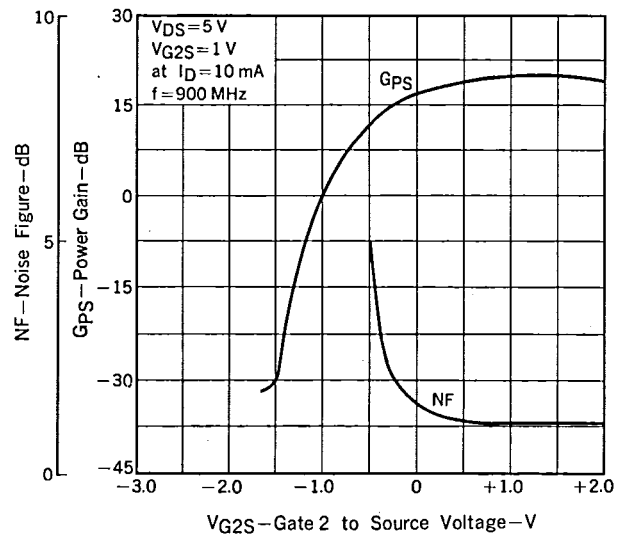
ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

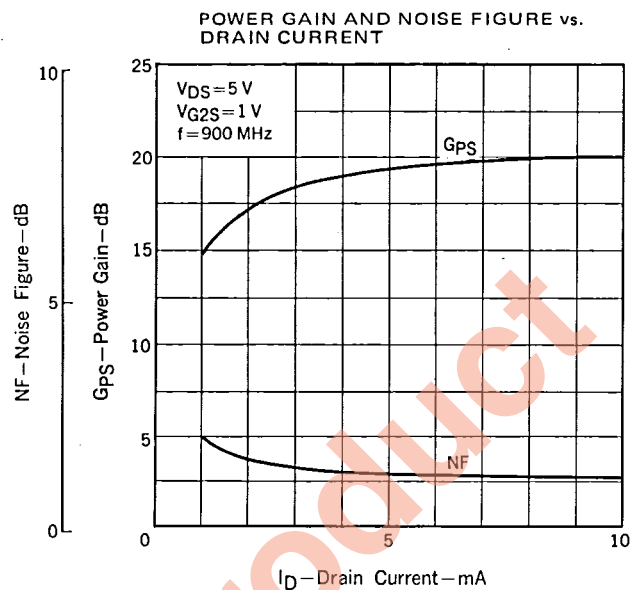
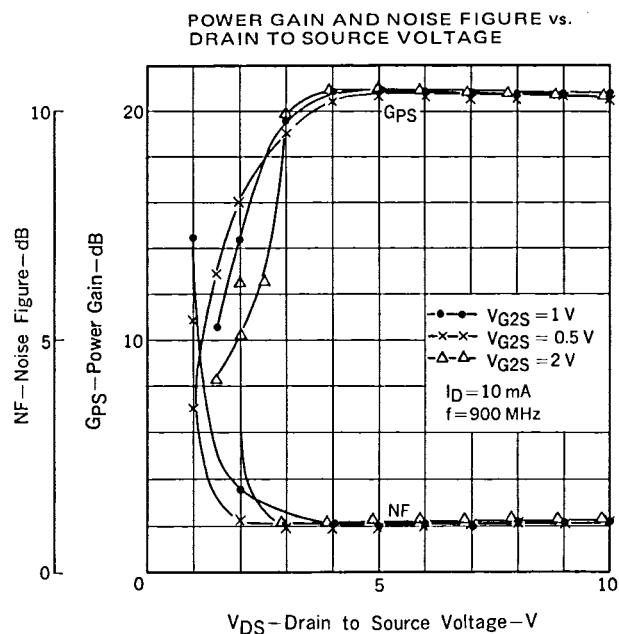
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source Breakdown Voltage	BV_{DSX}	13			V	$V_{G1S} = -4\text{ V}, V_{G2S} = 0, I_D = 10\text{ }\mu\text{A}$
Drain Current	I_{DSS}	5	20	40	mA	$V_{DS} = 5\text{ V}, V_{G2S} = 0, V_{G1S} = 0$
Gate1 to Source Cutoff Voltage	$V_{G1S(off)}$			-3.5	V	$V_{DS} = 5\text{ V}, V_{G2S} = 0, I_D = 100\text{ }\mu\text{A}$
Gate2 to Source Cutoff Voltage	$V_{G2S(off)}$			-3.5	V	$V_{DS} = 5\text{ V}, V_{G1S} = 0, I_D = 100\text{ }\mu\text{A}$
Gate1 Reverse Current	I_{G1SS}			10	μA	$V_{DS} = 0, V_{G1S} = -4\text{ V}, V_{G2S} = 0$
Gate2 Reverse Current	I_{G2SS}			10	μA	$V_{DS} = 0, V_{G2S} = -4\text{ V}, V_{G1S} = 0$
Forward Transfer Admittance	$ Y_{fs} $	18	25	35	mS	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 1.0\text{ kHz}$
Input Capacitance	C_{iss}	0.5	1.0	1.5	pF	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 1\text{ MHz}$
Reverse Transfer Capacitance	C_{rss}		0.02	0.03	pF	
Power Gain	G_{PS}	16.0	20.0		dB	$V_{DS} = 5\text{ V}, V_{G2S} = 1\text{ V}, I_D = 10\text{ mA}, f = 900\text{ MHz}$
Noise Figure	NF		1.1	2.5	dB	

I_{DSS} Classification

Unit: mA

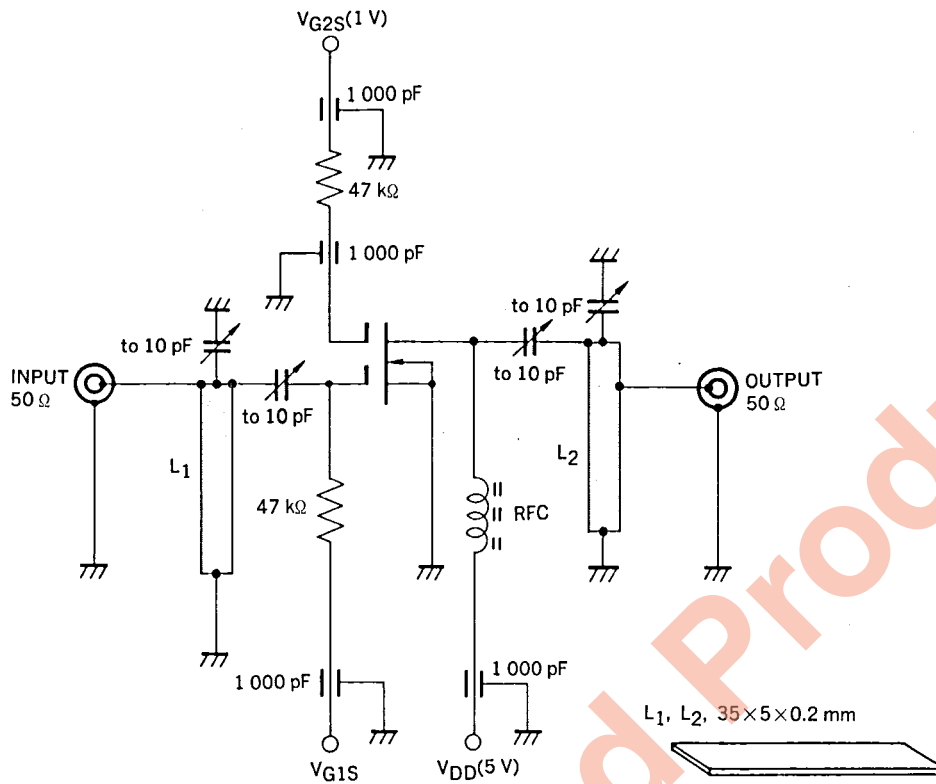
Marking	N	M	L	K
I_{DSS}	5 to 15	10 to 25	20 to 35	30 to 40

TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)TOTAL POWER DISSIPATION vs.
AMBIENT TEMPERATUREDRAIN CURRENT vs.
GATE1 TO SOURCE VOLTAGEFORWARD TRANSFER ADMITTANCE vs.
GATE1 TO SOURCE VOLTAGEFORWARD TRANSFER ADMITTANCE vs.
DRAIN CURRENTINPUT CAPACITANCE vs.
GATE2 TO SOURCE VOLTAGEPOWER GAIN AND NOISE FIGURE vs.
GATE2 TO SOURCE VOLTAGE

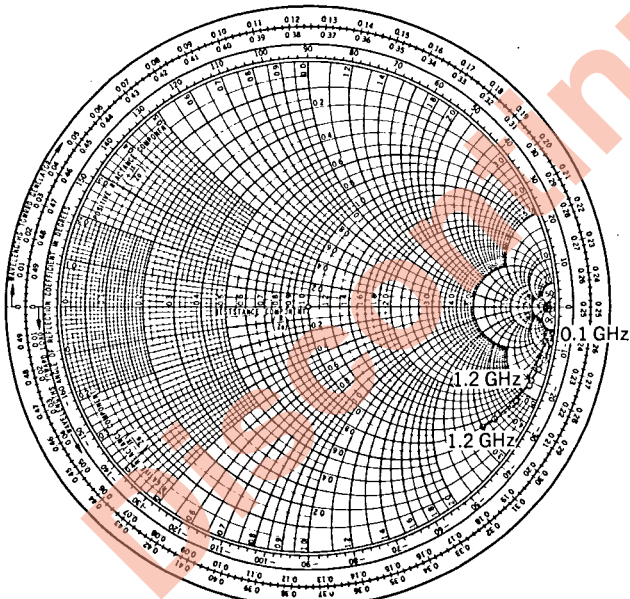


S-PARAMETER ($V_{DS} = 5\text{ V}$, $V_{G2S} = 1\text{ V}$, $I_D = 10\text{ mA}$)

FREQUENCY MHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
100.0000	0.993	-2.7	2.100	176.9	0.008	146.6	0.973	-1.5
200.0000	1.003	-6.2	2.140	169.8	0.009	55.7	0.976	-3.6
300.0000	0.994	-8.9	2.090	163.4	0.004	-12.9	0.981	-3.6
400.0000	0.982	-12.8	2.070	158.2	0.004	97.4	0.970	-6.0
500.0000	0.974	-14.7	2.115	156.8	0.010	82.9	0.975	-5.5
600.0000	0.946	-18.9	2.115	147.6	0.007	108.2	0.959	-9.2
700.0000	0.955	-19.6	2.068	143.8	0.005	102.4	0.980	-7.9
800.0000	0.931	-24.5	2.083	137.9	0.006	73.3	0.954	-11.4
900.0000	0.925	-25.5	2.161	136.2	0.007	80.2	0.980	-11.4
1000.0000	0.877	-30.4	2.122	125.5	0.001	138.9	0.950	-14.8
1100.0000	0.904	-30.6	2.154	122.8	0.003	111.5	0.975	-13.8
1200.0000	0.852	-35.3	2.186	115.9	0.002	129.9	0.945	-18.0

900 MHz G_{PS} AND NF TEST CIRCUIT

$V_{DS} = 5\text{ V}$, $V_{G2S} = 1\text{ V}$, $I_D = 10\text{ mA}$



○: S_{11} ×: S_{22}

